

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C (Note 9)
20V	4.6mΩ @ V _{GS} = 4.5V	50A
	8.7mΩ @ V _{GS} = 2.5V	36A

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Backlighting
- Power Management Functions
- DC-DC Converters

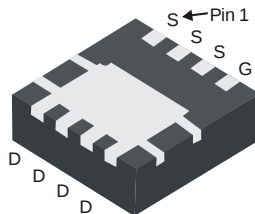
Features and Benefits

- Low R_{DS(ON)} – ensures on state losses are minimized
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- 100% UIS & Rg tested**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)**
- Qualified to AEC-Q101 Standards for High Reliability**
- An Automotive-Compliant Part is Available Under Separate Datasheet ([DMN2005UFGQ](#))**

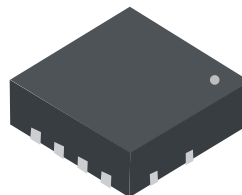
Mechanical Data

- Case: PowerDI[®] 3333-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish — Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.072 grams (Approximate)

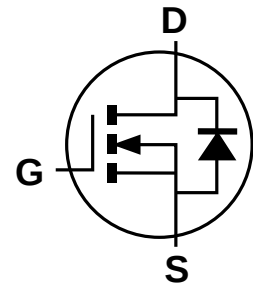
PowerDI3333-8



Bottom View



Top View



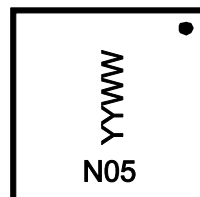
Equivalent Circuit

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2005UFG-7	PowerDI3333-8	2,000/Tape & Reel
DMN2005UFG-13	PowerDI3333-8	3,000/Tape & Reel

- Notes:
- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 - See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



N05= Product Type Marking Code
YYWW = Date Code Marking
YY = Last Two Digits of Year (ex: 19 = 2019)
WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±12	V
Continuous Drain Current (Notes 6 & 9) V _{GS} = 4.5V	Steady State	T _C = +25°C	I _D	50	A
		T _C = +70°C		40	
		T _A = +25°C	I _D	18	A
		T _A = +70°C		14	
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%)			I _{DM}	130	A
Maximum Continuous Body Diode Forward Current (Note 6)			I _S	2.6	A
Avalanche Current , L = 0.2mH			I _{AS}	23.9	A
Repetitive Avalanche Energy, L = 0.2mH			E _{AS}	58.4	mJ

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

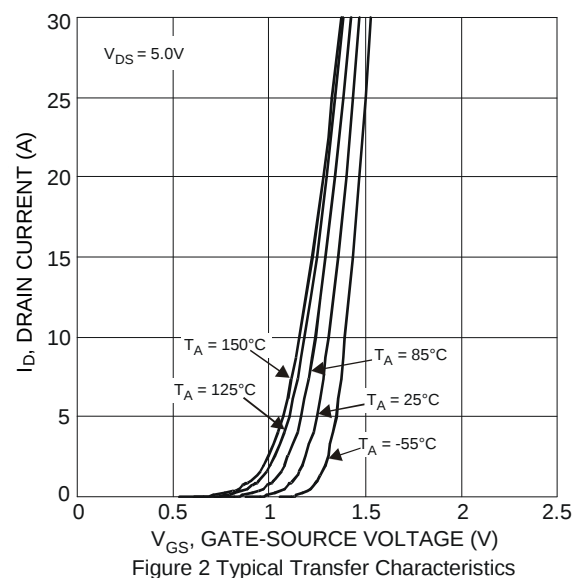
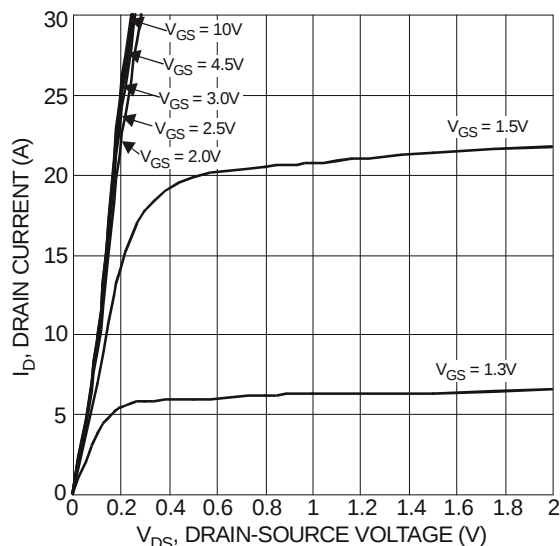
Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	P _D	1.05	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	R _{θJA}	120	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	P _D	2.27	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	R _{θJA}	55	°C/W
Thermal Resistance, Junction to Case (Note 6)		R _{θJC}	4.2	
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

Notes: 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	20	—	—	V	V _{GS} = 0V, I _D = 250μA
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	—	—	10	μA	V _{DS} = 20V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	V _{GS} = ±12V, V _{DS} = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.4	0.7	1.2	V	V _{DS} = V _{GS} , I _D = 250μA
Static Drain-Source On-Resistance	R _{DS(ON)}	—	4	4.6	mΩ	V _{GS} = 4.5V, I _D = 13.5A
		—	4.9	8.7		V _{GS} = 2.5V, I _D = 13.5A
Diode Forward Voltage	V _{SD}	—	0.8	1.1	V	V _{GS} = 0V, I _S = 27A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	—	6,495	—	pF	V _{DS} = 10V, V _{GS} = 0V, f = 1MHz
Output Capacitance	C _{oss}	—	546	—	pF	
Reverse Transfer Capacitance	C _{rss}	—	477	—	pF	
Gate Resistance	R _g	—	0.7	—	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz
Total Gate Charge (V _{GS} = 4.5V)	Q _g	—	68.8	—	nC	V _{DS} = 16V, I _D = 27A
Total Gate Charge (V _{GS} = 10V)	Q _g	—	164	—	nC	
Gate-Source Charge	Q _{gs}	—	10.4	—	nC	
Gate-Drain Charge	Q _{gd}	—	17.4	—	nC	
Turn-On Delay Time	t _{D(ON)}	—	12.4	—	ns	V _{GS} = 5V, V _{DS} = 10V, R _G = 4.7Ω, I _D = 13.5A
Turn-On Rise Time	t _R	—	25.7	—	ns	
Turn-Off Delay Time	t _{D(OFF)}	—	114	—	ns	
Turn-Off Fall Time	t _F	—	38	—	ns	
Body Diode Reverse Recovery Time	t _{RR}	—	16.1	—	ns	I _F = 13.5A, di/dt = 100A/μs
Body Diode Reverse Recovery Charge	Q _{RR}	—	8.5	—	nC	I _F = 13.5A, di/dt = 100A/μs

Notes: 7. Short duration pulse test used to minimize self-heating effect.
 8. Guaranteed by design. Not subject to product testing.
 9. Limited by package.



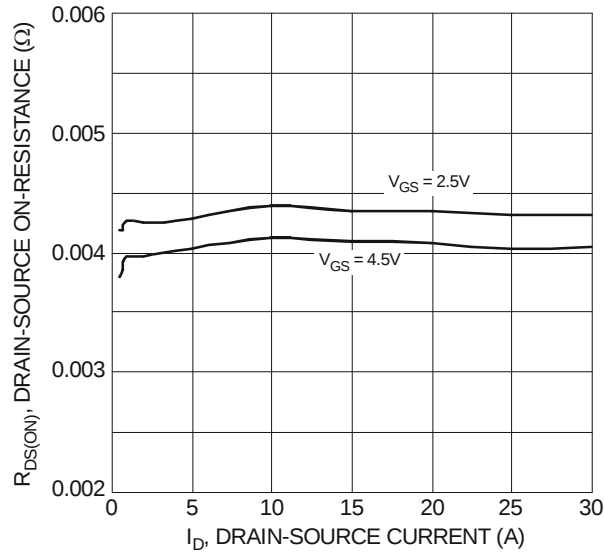


Figure 3 Typical On-Resistance vs. Drain Current and Gate Voltage

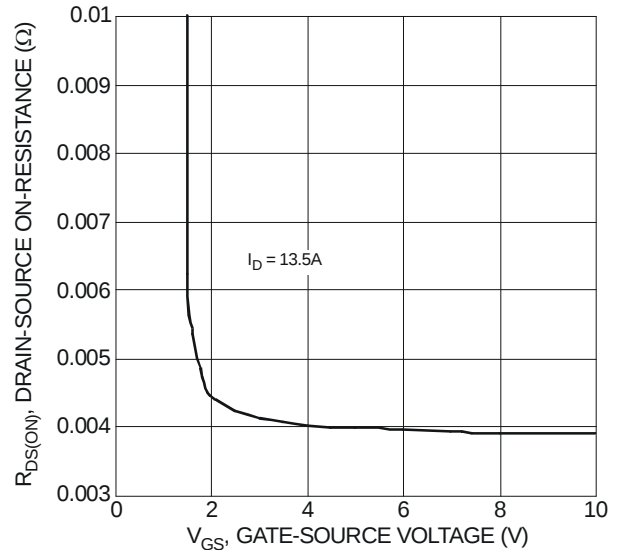


Figure 4 Typical Transfer Characteristic

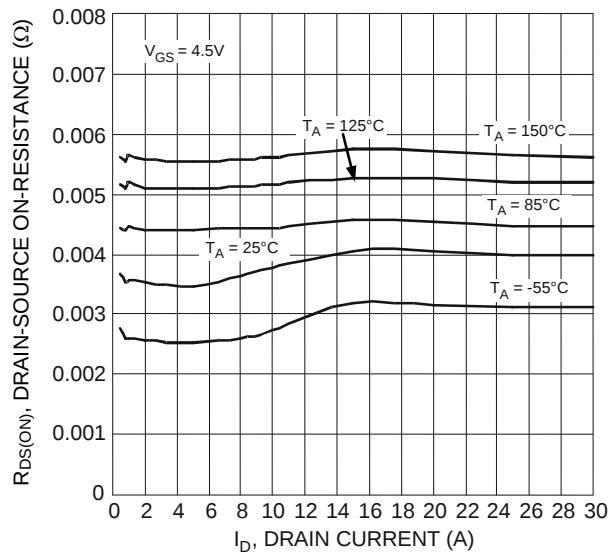


Figure 5 Typical On-Resistance vs. Drain Current and Temperature

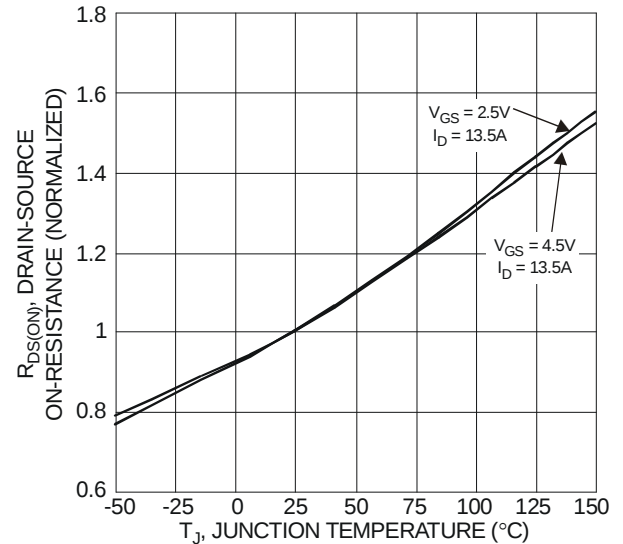


Figure 6 On-Resistance Variation with Temperature

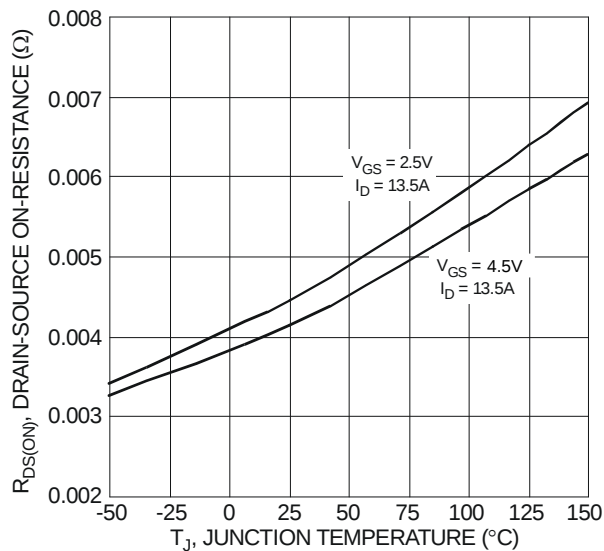


Figure 7 On-Resistance Variation with Temperature

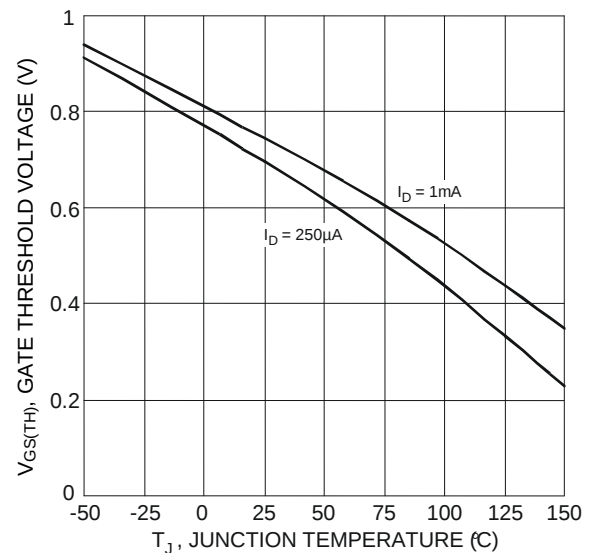


Figure 8 Gate Threshold Variation vs. Junction Temperature

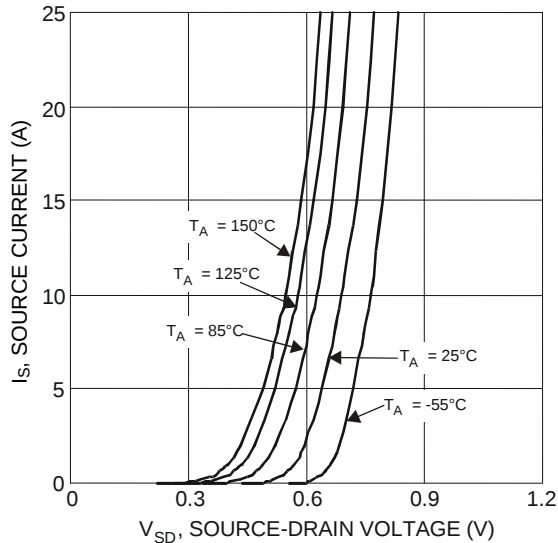


Figure 9 Diode Forward Voltage vs. Current

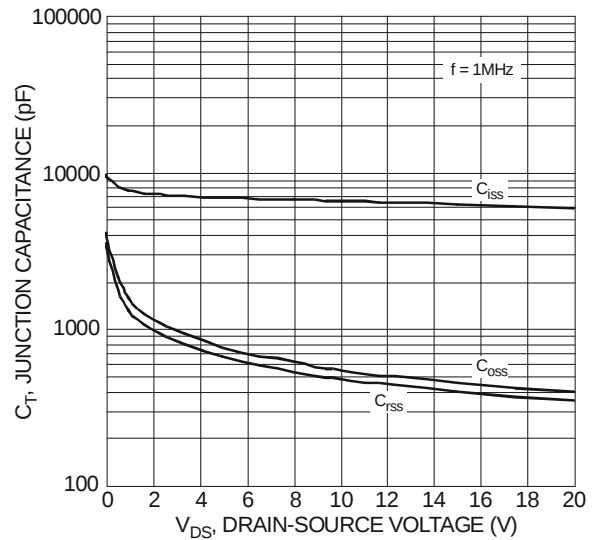


Figure 10 Typical Junction Capacitance

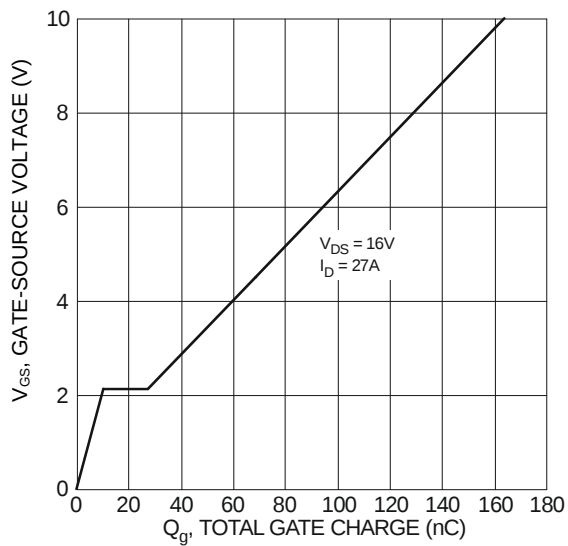


Figure 11 Gate Charge

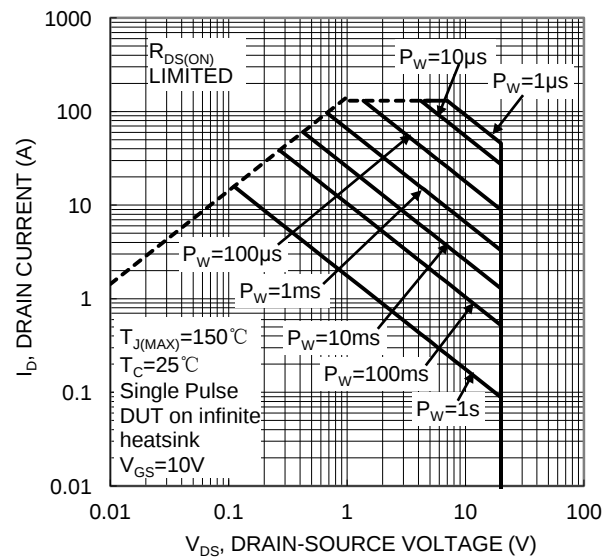


Figure 12. SOA, Safe Operation Area

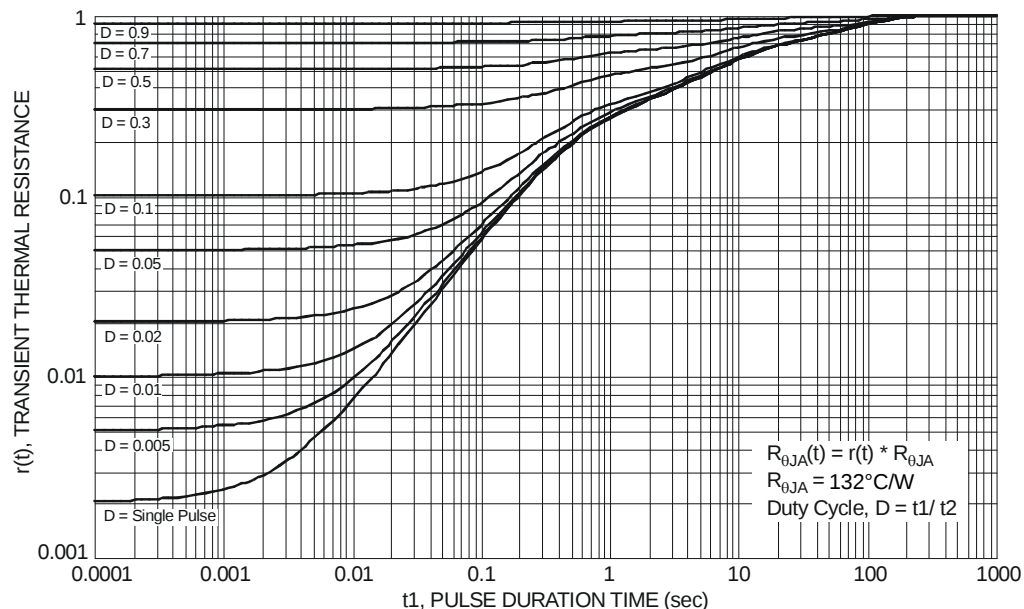
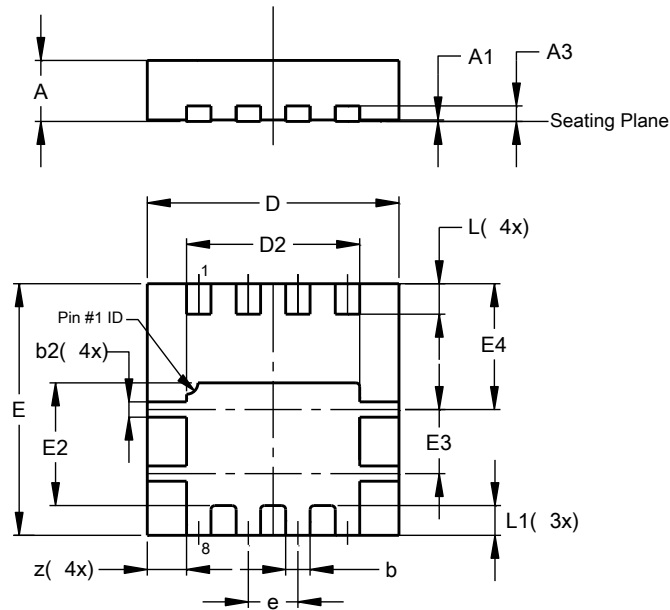


Figure 13 Transient Thermal Resistance

Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI3333-8

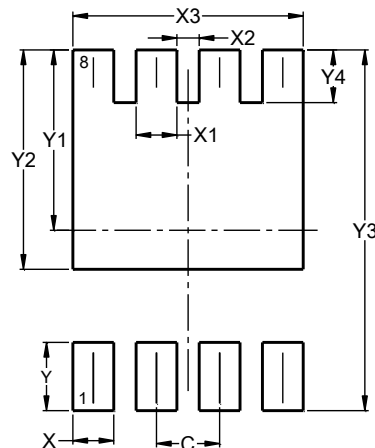


PowerDI3333-8			
Dim	Min	Max	Typ
A	0.75	0.85	0.80
A1	0.00	0.05	0.02
A3	—	—	0.203
b	0.27	0.37	0.32
b2	0.15	0.25	0.20
D	3.25	3.35	3.30
D2	2.22	2.32	2.27
E	3.25	3.35	3.30
E2	1.56	1.66	1.61
E3	0.79	0.89	0.84
E4	1.60	1.70	1.65
e	—	—	0.65
L	0.35	0.45	0.40
L1	—	—	0.39
z	—	—	0.515
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI3333-8



Dimensions	Value (in mm)
C	0.650
X	0.420
X1	0.420
X2	0.230
X3	2.370
Y	0.700
Y1	1.850
Y2	2.250
Y3	3.700
Y4	0.540

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